APPLICATION DATA SHEET

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Title of Invention

[MULTI-CHIP PACKAGE]

Application Type: regular, utility
Attorney Docket Number: 11238-US-PA

Request Not To Publish

I/We hereby request that the attached application not be published under 37 U.S.C. 122(b).

I/We hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.